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RE: Reflow Soldering Heat

The below NIC product series table includes the NIC Components product series which meet the reflow soldering requirements of IPC/JEDEC J-STD-020E

NIC SERIES
NCLP
NCLS

NCSA

NCSP NCSR

NCSS NCST NCST-A NCSW

NFR NRC NRCA NRC-AS

NRCL NRCP NRCPH NRCPS

NRCE

NRC-S NRCV NRCW

NRSNE NRSNE NRSNL NRSNS

NTR NTRA NTRC

NTRH

3-Times reflow maximum

+260°C Reflow Peak for 10 seconds

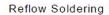
150 seconds maximum above +217°C

40 seconds maximum above +245°C

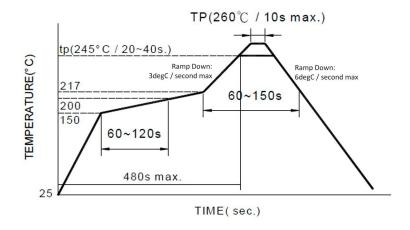
Ramp up (heat) rate of 3°C/second

Ramp down (cool) rate of 6°C/second

Do not force cooling



PRE-HEATING SOLDERING NATURAL COOLING



Reflow times: 3 times max

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